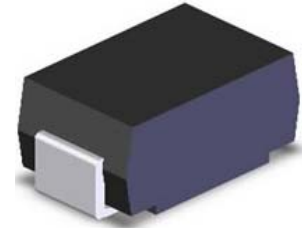


Features

- For surface mounted applications
- Metal silicon junction, majority carrier conduction
- Low power loss, high efficiency
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed:
250 °C/10 seconds at terminals
- The plastic package carries Underwriters Laboratory
Flammability Classification 94V-0

Mechanical Data

- Case: JEDEC DO-214AC molded plastic body
- Terminals: leads solderable per MIL-STD-750, Method 2026
- Mounting Position: Any
- Polarity: Color band denotes cathode end
- Weight: 0.005 ounce, 0.138 grams



SMA (DO-214AC)

Major Ratings and Characteristics

$I_{F(AV)}$	3.0 A
V_{RRM}	20V to 200V
I_{FSM}	60 A
V_F	0.55V, 0.70V, 0.85V
$T_j(max.)$	125 °C

■ **Maximum Ratings & Thermal Characteristics** ($T_A=25^{\circ}C$, unless otherwise noted)

Items	Symbol	SS32	SS33	SS34	SS35	SS36	SS38	SS310	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	80	100	V
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	56	70	
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	80	100	
Maximum average forward rectified current	$I_{F(AV)}$	3.0							A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	60							
Thermal resistance from junction to ambient ⁽¹⁾	$R_{\theta JA}$	55							°C/W
Operating junction and storage temperature range	T_j	-65 to +125							°C
Storage temperature range	T_{STG}	-65 to +125							

Note 1: Mounted on P.C.B. with 0.2 × 0.2" (5.0 × 5.0mm) copper pad areas.

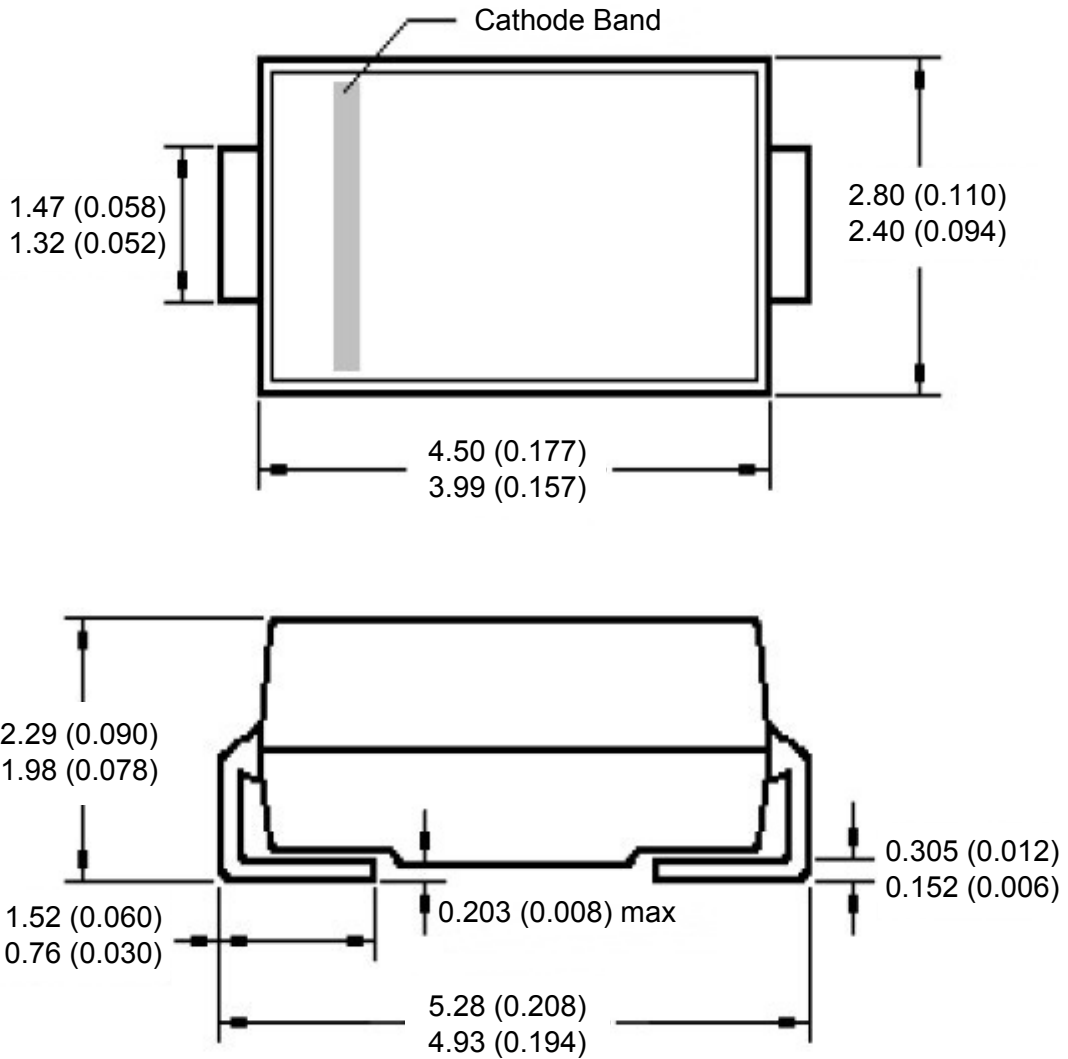
■ **Electrical Characteristics** ($T_A=25^{\circ}C$, unless otherwise noted)

Items	Test conditions	Symbol	SS32~SS34	SS35~SS36	SS38~SS310	UNIT
Instantaneous forward It	$I_F=3.0A$ ⁽²⁾	V_F	0.55	0.70	0.85	v
Reverse current	$V_R=V_{DC}$	I_R	$T_A=25^{\circ}C$			mA
			$T_A=100^{\circ}C$			
Typical junction capacitance	4.0V, 1MHz	C_j	500	300		pF

Note 2: Pulse test: 300µs pulse width, 1% duty cycle.

Package Outline

SMA DO-214AC



Dimensions in millimeters and (inches)

